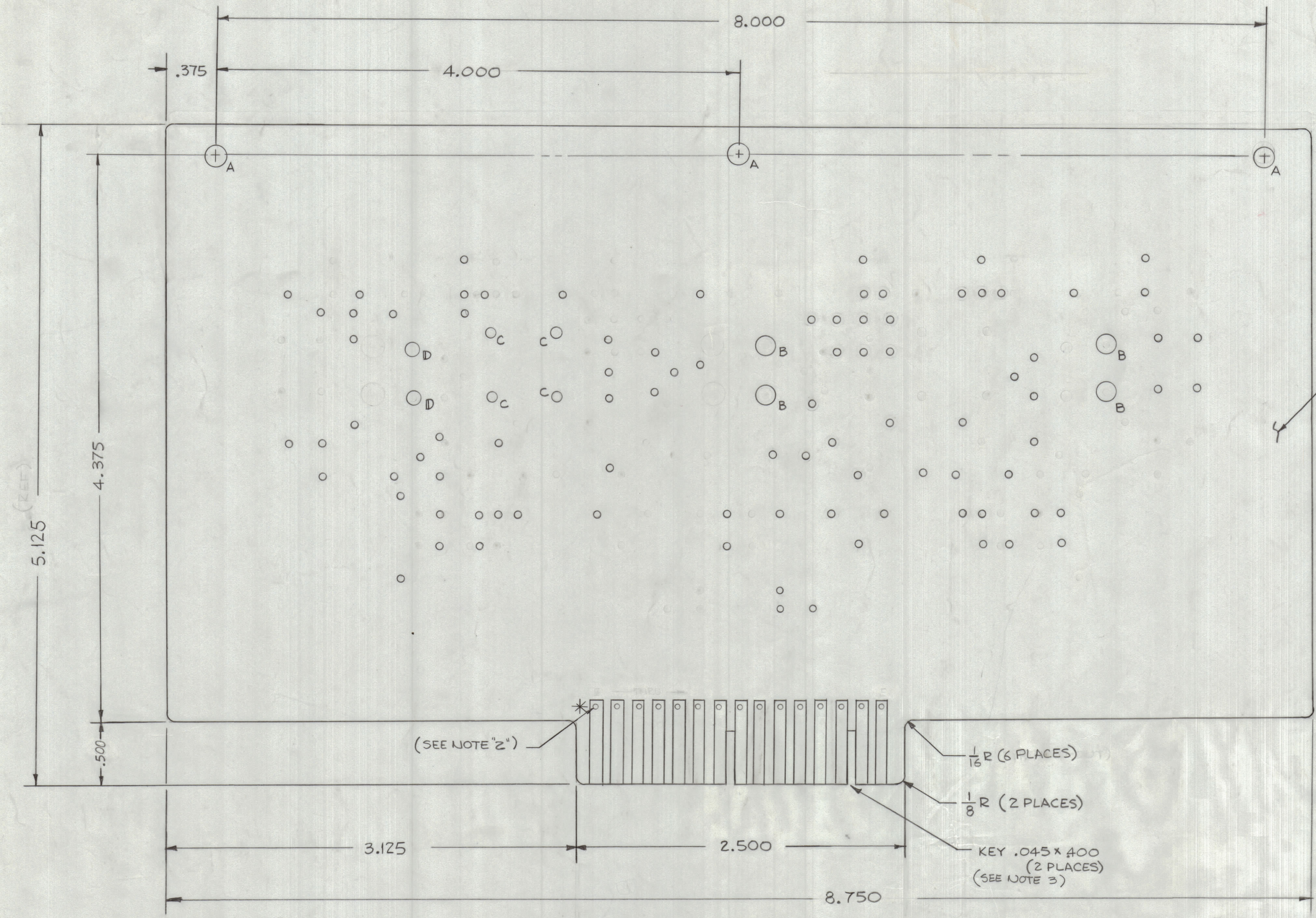


REVISIONS						
ZONE	SYM	DESCRIPTION	DATE	E.M.N. NO.	DRAFT	CHKD
	X	EXP. RELEASE	5-18-65	1		
	X1	See Sheet (one)D	5-24-65	2		
	D	ORIGINAL RELEASE FOR PRODUCTION	5-29-65	3		



HOLE	DESCRIPTION	REQ
A	11/64 DIA.	3
B	.166 DIA.	4
C	.062 DIA.	4
D	.096 DIA.	2
	UNMARKED HOLES .040 DIA	94

FABRICATION NOTES

1. MATERIAL THICKNESS .062±.0075 AS PER 3.2 13.2.2
- * 2. .040 DIA. PLATED THRU HOLES, TO BE LOCATED IN THE CENTER OF EACH FINGER CONTACT .050 AWAY FROM THE MAIN BODY OF BOARD.
3. THE PRINTED CIRCUIT BOARDS SHALL BE KEYED WITH SLOTS .050-.070 WIDE & .400 HIGH LOCATED BETWEEN FINGER CONTACTS 7&8, 13, 14 AS VIEWED FROM COMPONENT SIDE OF BOARD.
4. EDGE BOARD CONNECTOR (FINGER) SHALL BE GOLD PLATED 10.1 CONDUCTIVE PATTERN SHALL BE SOLDER COATED (PP13.3 & PP13.3.1)
5. HOLES TO BE PLATED THRU AS PER (PP11.4)
6. KEY SLOTS TO BE DEBURRED.
7. FOR SPARE PARTS USE ON MODEL LFSB-1 SERIAL NO. 16336 THRU 16361, BOARD THICKNESS MUST BE .093 (3/32)

CIRCUIT SIDE

(SEE NOTE "Z")

1/16 R (6 PLACES)
 1/8 R (2 PLACES)
 KEY .045 x .400 (2 PLACES)
 (SEE NOTE 3)

NOTES

QTY/UNIT	MODEL USED ON	ASSY. NO.
1	LFSB-1	A3741
SCALE	CODE	
2:1		

REQ'D	ITEM	PART NUMBER	DESCRIPTION	SYMBOL
LIST OF MATERIAL				
MATERIAL		THE TECHNICAL MATERIEL CORP. MAMARONECK, NEW YORK		
FINISH		PRINTED CIRCUIT BOARD		
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES AND INCLUDE CHEMICALLY APPLIED OR PLATED FINISHES		DRAWN	DATE	FINAL APPROVAL
CHECKED		DATE	DATE	DATE
ELECT. DES.		DATE	DATE	DATE
MECH. DES.		DATE	DATE	DATE
TOLERANCES		SHEET 2 OF 2		

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